## **ABSTRACT**

A system for electric testing PCB/MCM before and after assembly. The system uses energy taken from a heating source, timely applied at certain ports of the PCB/MCM (entry ports). The energy is defused through the board inner layer tracks terminating at the end of the channel tracks of the PCB/MCM (exit ports). The rate of energy diffusion on the board is measured at the terminating ports in the time domain. The thermal emission is measured by a spectrometer that conducts infrared scans and analyzes the PCBs energy spectrum. Measurements can be taken as discrete measurements or as integrated measurements. The measurements results are compared with the prememorized values of a group of patterns that represent respective golden board. Defect analysis is automatically achieved based on learned defect test patterns.